

O I P E
JUN 28 2002
PATENT & TRADEMARK OFFICE

2826

TRANSMITTAL LETTER
(General - Patent Pending)

Docket No.
END920000149US1

In Re Application Of: Adae-Amoakoh et al.

Serial No.

09/827,014

Filing Date

4/5/01

Examiner

Andujar, Leonardo

Group Art Unit

2826

RECEIVED
TECHNOLOGY CENTER 2800
JUL -2 2002

Title: METHOD AND STRUCTURE FOR ECONOMICAL HIGH DENSITY CHIP CARRIER

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is:

Response to Restriction

in the above identified application.

- No additional fee is required.
- A check in the amount of _____ is attached.
- The Assistant Commissioner is hereby authorized to charge and credit Deposit Account No. 09-0457(IBM) as described below. A duplicate copy of this sheet is enclosed.
 - Charge the amount of _____
 - Credit any overpayment.
 - Charge any additional fee required.

Jack P. Friedman
Signature

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Dated: 6/25/02

I certify that this document and fee is being deposited on 6/25/02 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

Kim Dwileski
Signature of Person Mailing Correspondence

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Kim Dwileski
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